

INDIVIDUAL SPECIFICATION SHEET

Product Name: 0603 Time Delay SMD Fuse

Part Number: F06T2

Revision: B



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Rev.	Effective Date	Changed Contents	
A	2020-9-27	New Release	
В	2021-4-7	Update Spedfications	

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Description

F06T Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.

Rated Current	1.0In	2.5In
2A	4 hour minimum	5 sec maximum

Features

- High inrush current withstanding capability
- AEC-Q200 Automotive Grade Certified
- Compatible with reflow and wave solder
- Ceramic and glass construction
- Excellent environmental integrity
- One time positive disconnect
- Lead Free and Halogen free material

Specifications

Specification									
Part No.	Rated Rated Voltage Current	Breaking Capacity (A)	Typical Cold. Resistance	Typical Voltage	Typical Pre- Arcing I ² t	Alpha			
	DC	(A)	1	(mOhms) ²	Drop (mV)	$(A^2Sec)^3$	Mark		
F06T2	32V	2	50A	72	160	0.115	K		

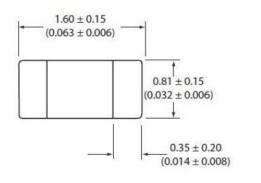
1. DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)

2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25degrees

3.Typical Pre-arcing I²t are measured at 10In Current.

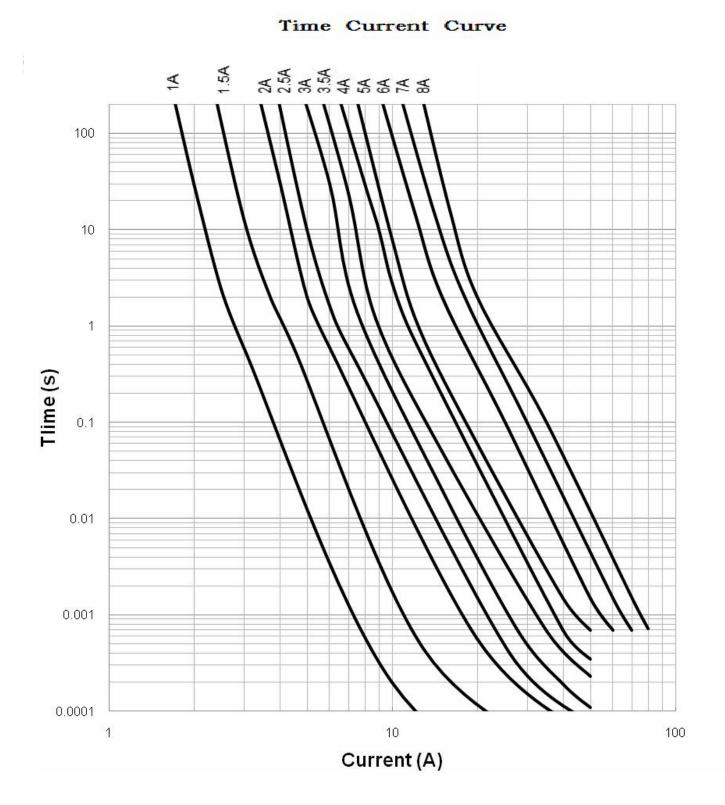
Specifications are subject to change without notice. Application testing is strongly recommended.

Dimension Drawing not to scale (Unit: mm/inch)



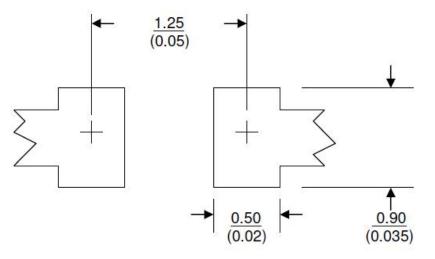








Recommended land pattern

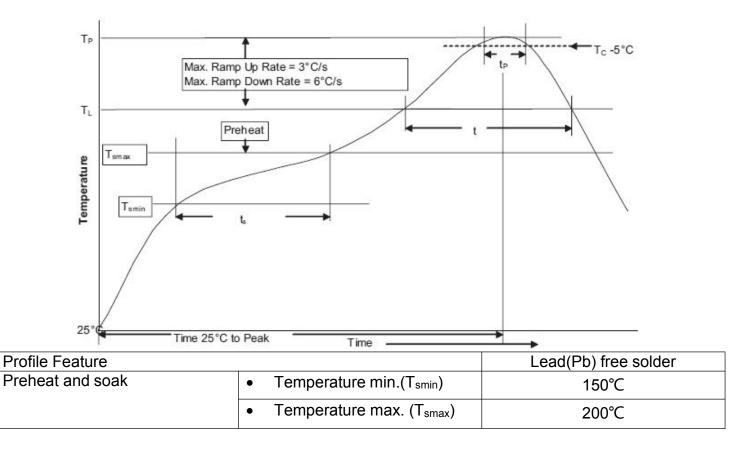


Unit: mm/inches

Soldering method

- > Wave solder
 - Reservoir temperature: 260°C
 - Time in reservoir: 10 seconds maximum
- Infrared reflow
 - Temperature: 260°C
 - Time: 30 seconds maximum

Solder reflow profile



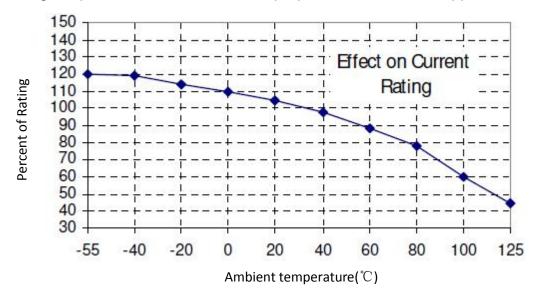


• Time (T _{smin} to T _{smax}) (t _S)	60 - 120 Seconds		
Average ramp up rate T_{smax} to T_p	3°C / Second Max.		
Liquidous temperature (T _L)	217°C		
Time at liquidous (t _L)	60 - 150 Seconds		
Peak package body temperature (T _P)	260°C		
Time (t _P) within 5°C of the specified classification temperature (T _C)	30 Seconds		
Average ramp-down rate (T _P to T _{smax})	6°C / Second Max.		
Time (25°C to Peak Temperature)	8 Minutes Max.		

Temperature Derating Curve

Normal ambient temperature: 23+/-3°C

Operating temperature: -55 ~ 125°C, with proper correction factor applied



Package

5000 fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481.

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